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PCB specification

A

B

C

D

E

F

G

H

PCB base material according to R04350 specifications
Glass Transition (Tg) > 280C

*

Nominal thickness 1.5mm (include copper foil on both sides).
Double-sided, final thickness without solder mask < 1.64mm.
Base copper clad 18um,final copper clad > 60um on on both sides.
Surface HAL leadfree (SnCu- base alloy without Ag).

base material

top copper

bottom copper

hole

toleranced DIN				tolerance	change date	num- ber	modification		28.11.2016	S.Kulik	S.Kulik			
thread according to DIN				surface:				scale:	Date					
german projection				material:				material type:	substitution for dimensions w/o tolerance:					
								FSK Modulator						
semi finished product				project version				TDE						
material consumption:								PN10055				1		
weight:												6		
number of pieces per package:				Format: DIN A 3				Classing:						

Supporting regulations which apply

mailing:

V:

ZV:

For this drawing we reserve ourselves all rights
+ Pay attention to protection note according to DIN ISO 16016
+ Changes from the supplier need the previous
approval by TDE

Handwritten
remarks
are not allowed